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CUSTOMER PTC

SAMPLE CODE SH320240T023-IBC

MASS PRODUCTION CODE PH320240T023-IBC

SAMPLE VERSION 02

SPECIFICATIONS EDITION 006

DRAWING NO. (Ver.) LMD-PH320240T023-IBC_003

PACKAGING NO. (Ver.) JPKG-PH320240T023-IBC_003

Customer Approved

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Preliminary specification for design input

Specification for sample approval

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History of Version

F					T
Date	Ver.	Edi.	Description	Page	Design by
08/23/2013	01	001	New Drawing.	-	Ackey
09/12/2013	01	002	New Sample	-	Ackey
09/24/2013	01	003	Update Data.	-	Ackey
04/03/2014	01	004	Modify TP content. Add CN & Initcode.	8,13, Appendix	Ackey
08/25/2015	01	005	Show Backlight Life Time	8	張斌
09/25/2018	02	006	Second Sample(Change CTP)	-	陳璐
				<i></i>	

Total: 35 Page



Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics
- 1.7 Touch Panel Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description 2.2.1 Refer Initial code
- 2.3 Timing Characteristics

3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

4. RELIABILITY TEST

4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix : LCM Drawing

Note: For detailed information please refer to IC data sheet:

Primacy(TFT LCD): Himax: HX8238-D



1. SPECIFICATIONS

1.1 Features

Main LCD Panel

Item	Standard Value		
Display Type	320* (R · G · B) * 240 Dots		
LCD Type	Normally white , Transmissive type		
Touch panel	Projective capacitive touch panel True Multi-touch with up to 5 Points of Absolution		
Screen size(inch)	3.5(Diagonal)		
Viewing Direction	6 O'clock		
Color configuration	R.G.B. vertical stripe		
Interface	Digital 24-bits Parallel RGB HSYNC,VSYNC,3Wires SPI		
Other (controller / driver IC)	Himax:HX8238-D		
	THIS PRODUCT CONFORMS THE ROHS OF PTC		
ROHS	Detail information please refer website : http://www.powertip.com.tw/news.php?area id view=1085560481/		

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension(T/P)	84.02(W) x 75.36 (L) x 5.2(H)(MAX)	mm

LCD panel

Item	Standard Value	Unit
Active Area	70.08 (W) x 52.56 (L)	mm

Touch panel

Item	Item Standard Value	
Viewing Area	71.68 (W) * 54.16 (L)	mm

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDD	GND=0	-0.3	4.0	٧
Booster Reference Supply Voltage	VCI	GND=0	GND-0.3	3.96	٧
Operating Temperature	Top	Excluded T/P	-20	70	°C
Storage Temperature	T _{ST}	Excluded T/P	-30	80	°C

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = $25^{\circ}C$

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	VDD	-	3.0	3.3	3.6	V
Booster Reference Supply Voltage	VCI		3.0	3.3	3.6	V
V _{сом} High Voltage	Vсомн	-	-	-	5.54	V
V _{сом} Low Voltage	Vcoml	-	-2.8	-	-	V
Input LI/I Lovel Voltage	VIH	-	0.8VDD	-	VDD	V
Input H/L Level Voltage	VIL	-	0	-	0.2VDD	V
Output H/L Lovel Voltage	VOH	-	0.9VDD	-	VDD	V
Output H/L Level Voltage	VOL		-	-	0.1VDD	V
Supply Current	IDD	VDD=VCI=3.3V*1	-	9	14	mA

Note1: Maximum current display.



1.5 Optical Characteristics

TFT LCD Panel

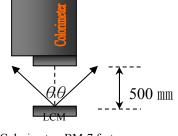
VDD=VCI=3.3V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response time		Tr + Tf	-	-	40	60	ms	Note2
	Тор	θΥ+		-	60	-		
Viewing angle	Bottom	θΥ-	CR ≥ 10	-	60	-	Dog	Note4
viewing angle	Left	θX-		-	60	-	Deg.	Note4
	Right	θX+		-	60	-		
Contrast ratio		CR		500	600	-	-	Note3
	White	Х		0.27	0.32	0.37		
		Y	IF= 20 mA	0.29	0.34	0.39		
0 1 (0)5	Red	Х		0.57	0.62	0.67		
Color of CIE Coordinate		Υ		0.31	0.36	0.41	_	Note1
(With B/L & T/P)	Green	Х		0.29	0.34	0.39		NOLET
(**************************************		Υ		0.56	0.61	0.66		
	Blue	X		0.09	0.14	0.19		
	Diue	Y		0.03	0.08	0.13		
Average Brightness Pattern=white display		IV	IF= 20 mA	350	400	-	cd/m ²	Note1
Uniformity		△B	11°- 20 111A	80	-	-	%	Note1

Note1:

- $1 : \triangle B=B(min) / B(max) \times 100\%$
- 2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





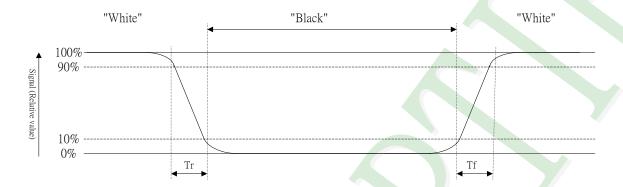
Colorimeter=BM-7 fast



Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

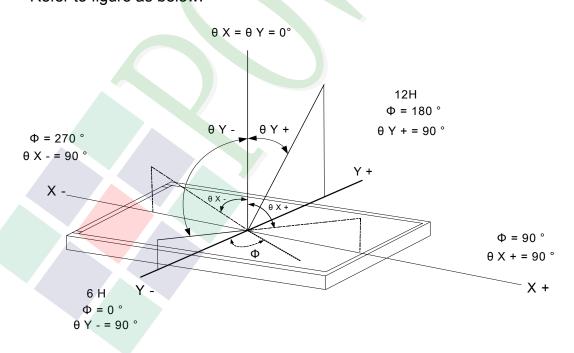
Contrast ratio is calculated with the following formula

Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle: Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°℃	-	30	mA
Reverse Voltage	VR	Ta =25°℃	- (5	V
Power Dissipation	PD	Ta =25°℃	-	30*21	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		16.8	19.2	21.0	V
Luminance	Lv	IF= 20 mA	4500	6000	8500	cd/m ²
Color of CIE Coordinate	Х	IF- ZU IIIA	0.28	-	0.32	
(Without LCD & TP)	Y		0.28	-	0.32	_
Color			White		•	•

Internal Circuit Diagram



Other Description

Item	Conditions	Description
Life Time	Ta =25°ℂ	20000 hrs
Life Time	IF= 20mA	20000 hrs



1.7 Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	3.5"
Tauch time	Projected Capacitive Touch
Touch type	True Multi-Touch Capacitive Touch Panel
Input Method	True Multi-touch with up to 5 Points of Absolution
input Metriod	X and Y Coordinates
Output Interface	l ² C
IC	FT5346

I²C Address

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	1	1	1	0	0	0	R/W

Bit 0: 0 for Write / 1 for Read

Mechanical Specifications

Item	Standard Value	Unit
Viewing Area	71.68 mm (W) x 63.50mm (H)	mm
Number of sensing channel	16 (W) x 10 (H)	mm

Absolute Maximum Ratings

	3				
Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	VDD	-	-0.3	3.6V	V
Operating Temperature	Top	-	-20	+70	°C
Storage Temperature	T _{ST}	-	-30	+80	°C

DC Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Power Supply Voltage	VDD	-	3.0	3.3	3.6	V



I²C Read/Write Interface description

Write N bytes to I2C slave

		5	Sla	ve .	Ado	dr				Da	ta A	Add	lres	s[2	[]					Ι	Data	a [2	K]					D	ata	[X-	⊦N-	1]			
S	A 6	A 5	. A 4	A 3	A 2	A 1	A 0	R W	A ,	R R	R	R 4	R 3	R 2	R 1	R 0	A	D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	A	 D :	D .	D I) [3) D	1	D 0	A	P
START					_			WRITE	ACK	, 0				_	_		ACK	•					_		•	ACK	•				4		•	ACK	STOP

Set Data Address

		5	Slav	ve 1	Ado	$d\mathbf{r}$			Data Address[X]										
C	A	A	A	Α	A	Α	A	R	Λ	R	R	R	R	R	R	R	R	Λ	D
3	6	5	4	3	2	1	0	W	A	7	6	5	4	3	2	1	0	A	Г
S								V											
STAR								\aleph	A									A	ST
R								Ξ	×									×	P
								CTJ											

Read X bytes from I2C Slave

		Sla	ve	Ad	dr					I	Dat	a [.	N]						I	Dat	a [2	X+	N-1	[]			
S	 . A	. A 4	. A	A 2	A 1	A 0	R W	A	D 7	D 5				D 1	D 0	A		D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	A	P
START							Read	ACK								ACK										ACK	STOP

Mnemonics Description

Mnemonics	Description
S	I2C Start or I2C Restart
A[6:0]	Slave address
	A[6:0]:0111000b
R/W	'1' for read, '0' for write
A(N)	ACK(NACK)
P	STOP: the indication of the end of a packet (if this bit is missing, S will
	indicate the end of the current packet and the beginning of the next packet)

Timing Characteristics

Parameter	Unit	Min	Max
SCL frequency	KHz	0	400
Bus free time between a STOP and START condition	us	4.7	Λ.
Hold time (repeated) START condition	us	4.0	\
Data setup time	ns	250	\
Setup time for a repeated START condition	us	4.7	\
Setup Time for STOP condition	us	4.0	\



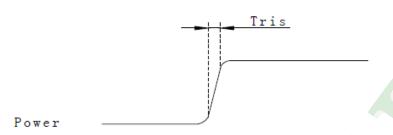


Figure 2-6-1: Power on time

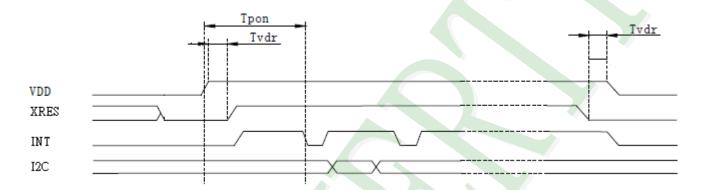


Figure 2-6-2: Power on Sequence

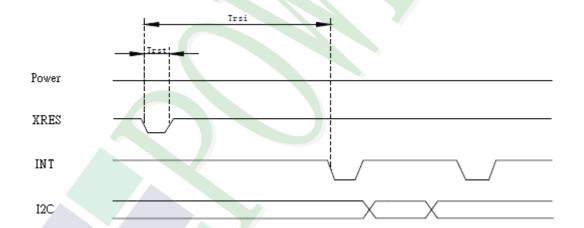


Figure 2-6-3: Reset Sequence

Power on / Reset Sequence Parameters

Parameter	Description	Min	Max	Units
Tris	Rise time from 0.1VDD to 0.9VDD		5	ms
Tpon	Time of starting to report point after powering on	200		ms
Tv d r	Reset time after VDD powering on	1		ms
Trsi	Time of starting to report point after resetting	200		ms
Trst	Reset time	1		ms



Interrupt signal from CTP to Host

As for standard CTP, host need to use both interrupt control signal and serial data interface to get the touch data. There are two kind of method to use interrupt: interrupt trigger and interrupt query.

Here is the timing to get touch data.

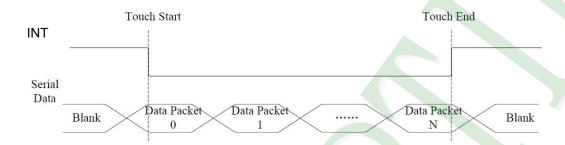


Figure 2-6-4: Interrupt query mode

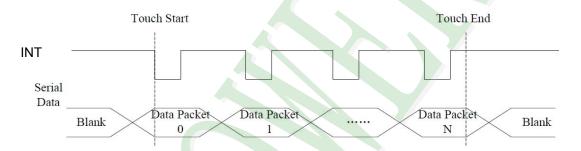


Figure 2-6-5: Interrupt trigger mode

Host use general I2C protocol to read the touch data or the information from CTP. CTP will send host a interrupt signal when there is a valid touch. Then host can use the serial data interface to get the touch data. If there is no valid touch detected, the INT will not be pulled up, the host do not need to read the touch data.

NOTE: "valid touch" may have different definition in various systems. For example, in some systems, the valid touch is defined as there is one more valid touch point. But in some other systems, the valid touch is defined as one more valid touch with valid gestures. In usual, INT will be pulled up when there is a valid touch point, and to be low when a touch finishes.

As for interrupt trigger mode, INT signal will be low if there is a touch detected. But for per update of valid touch data, CTP will produce a valid pulse for INT signal, host can read the touch data periodically according to the frequency of this pulse. In this mode, the pulse frequency is the touch data update frequency.



2.6.1.3 CTP Register Mapping

Address	Name	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Host Access
00h	DEVIDE_MODE	- Device Mode[2:0]		-	-	_	-	WR		
01h	TD_STATUS				Number of touch points[3:0]		R			
02h	TOUCH1_XH	1st Eve	1st Event Flag 1st Touch X Position[11:8]			11:8]	R			
03h	TOUCH1_XL		1st Touch X Position[7:0]					R		
04h	TOUCH1_YH		1st Toucl	n ID[3:0]		1st T	Touch Y I	Position[11:8]	R
05h	TOUCH1_YL			1st	Touch Y	Position[7:0]			R
06h	-					-				R
07h	-					-				R
08h	TOUCH2_XH	2st Eve	nt Flag	-	-	2st T	Touch X I	Position[11:8]	R
09h	TOUCH2_XL			2st	Touch X	Position[7:0]			R
0Ah	TOUCH2_YH		2st Toucl	n ID[3:0]		2st 7	Touch Y I	Position[11:8]	R
0Bh	TOUCH2_YL			2st	Touch Y	Position[7:0]			R
0Ch	-							R		
0Dh			-				R			
0Eh	TOUCH3_XH	3st Eve	3st Event Flag 3st Touch X Position[11:8]				R			
0Fh	TOUCH3_XL		3st Touch X Position[7:0]				R			
10h	TOUCH3_YH		3st Toucl	n ID[3:0]		3st T	Touch Y I	Position[11:8]	R
11h	TOUCH3_YL			3st	Touch Y	Position[7:0]			R
12h	-					_				R
13h	-					_				R
14h	TOUCH4_XH	4st Eve	nt Flag		-	4st T	ouch X I	Position[11:8]	R
15h	TOUCH4_XL			4st	Touch X	Position[7:0]			R
16h	TOUCH4_YH		4st Toucl	n ID[3:0]		4st T	Touch Y I	Position[11:8]	R
17h	TOUCH4_YL			4st	Touch Y	Position[7:0]			R
18h	-					_				R
19h	-/					_				R
1Ah	TOUCH5_XH	5st Eve	nt Flag	-	-	5st T	Touch X I	Position[11:8]	R
1Bh	TOUCH5_XL	5st Touch X Position[7:0]					R			
1Ch	TOUCH5_YH		5st Touch ID[3:0] 5st Touch Y Position[11:8]					R		
1Dh	TOUCH5_YL		5st Touch Y Position[7:0]				R			
1Eh	-		-				R			
1Fh	-		-					R		



DEVICE MODE

This register is the device mode register, configure it to determine the current mode of the chip.

Address	Bit Address	ldress Register Name Description	
001	6 . 1	Davies Made [2:0]	000b Work Mode
00h	6 : 4	Device Mode [2:0]	100b Factory Mode – read raw data

TD STATUS

This register is the Touch Data status register.

Address	Bit Address	Register Name	Description
	7:4	Reserved	
01h	2 · 0	Number of touch	How many points detected.
	3:0	points[3:0]	1-5 is valid.

TOUCHn XH

This register describes MSB of the X coordinate of the nth touch point and the corresponding event flag.

Address	Bit Address	Register Name	Description
			00b: Put Down
	7:6	Event Flag	01b: Put Up
021			10b: Contact
02h			11b: Reserved
	5:4		Reserved
	3:0	Touch X Position [11:8]	MSB of Touch X Position in pixels

TOUCH_n XL

This register describes LSB of the X coordinate of the nth touch point

Address	Bit Address	Register Name	Description
03h	7:0	Touch X Position [7:0]	LSB of the Touch X Position in pixels

TOUCHn YH

This register describes MSB of the Y coordinate of the nth touch point and corresponding touch ID.

Address	Bit Address	Register Name	Description
04h	7:4	Touch ID[3:0]	Touch ID of Touch Point
0411	3:0	Touch Y Position [11:8]	MSB of Touch Y Position in pixels

TOUCHn_YL

This register describes LSB of the Y coordinate of the nth touch point.

Address	Bit Address	Register Name	Description
05h~	7:0	Touch Y Position[7:0]	LSB of The Touch Y Position in pixels



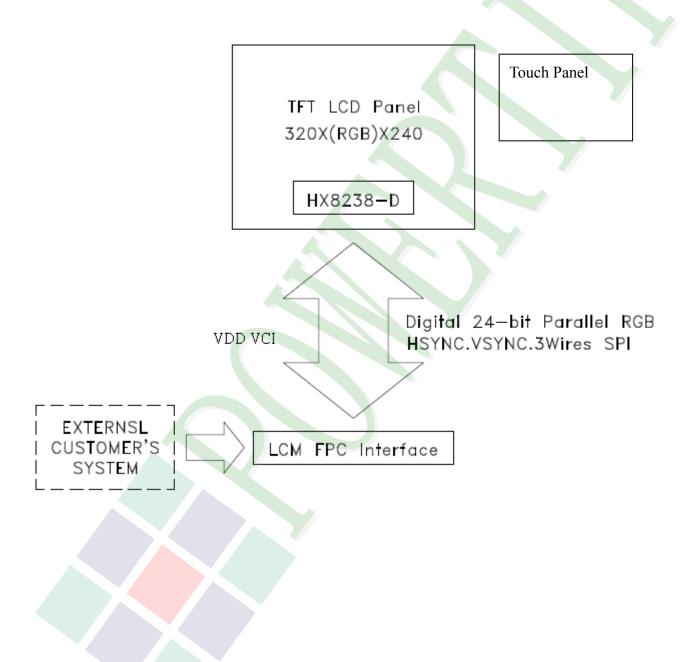
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

Pin No.	Symbol	Function
1	А	LED Anode.
2	К	LED Cathode.
3	GND	Ground.
4	VCI	Booster Reference Supply Voltage.
5	ID	Note1.
6	VDD	Power Supply Voltage.
7	GND	Ground.
8	RESB	Reset.
9	CSB	Chip select Input: CSB = L - selected and accessible. CSB = H - is not selected and not accessible.
10	SCK	SPI Clock Input.
11	SDO	SPI Data Output. The data is valid on the falling edge of the SCK signal.
12	SDI	SPI Data Input. The data is latched on the rising edge of the SCK signal.
13	GND	Ground.
14	В0	
15	B1	
16	B2	
17	В3	Graphic display Blue data.
18	B4	
19	B5	
20	B6	



Pin No.	Symbol	Function			
21	B7	Graphic display Blue data.			
22	G0				
23	G1				
24	G2				
25	G3	Craphia dianlay Croop data			
26	G4	Graphic display Green data.			
27	G5				
28	G6				
29	G7				
30	R0				
31	R1				
32	R2				
33	R3				
34	R4	Graphic display Red data.			
35	R5				
36	R6				
37	R7				
38	GND	Ground.			
39	DCLK	Video Clock Input. The data is latched on the rising edge of DCLK.			
40	HSYNC	Horizontal Sync Input.			
41	VSYNC	Vertical Sync Input.			



Pin No.	Symbol	Function
42	DEN	Video Data Enable Input. VSYNC+HSYNC mode - This pin is shorted to GND normally and the back/front porch is determined by the control register. VSYNC+HSYNC+DE mode - The valid data is determined by the VSYNC+HSYNC+DEN pin. DE mode - VSYNC and HSYNC are unused and shorted to GND. The valid input. data is determined by DEN pin.
43	GND	Ground.
44	SEL0	
45	SEL1	Note2.
46	SEL2	
47	NC	Not use.
48	NC	Not use.
49	NC	Not use.
50	NC	Not use.

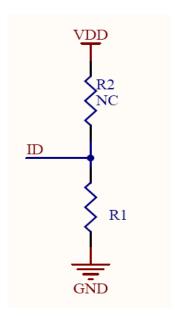
T/P PIN

Pin No.	Symbol	Function
1	GND	Ground.(T/P)
2	SDA	I ² C Data.(T/P)
3	SCL	I ² C Clock. (T/P)
4	VDD	Power.(T/P)
5	INT	The interrupt from the CTP to the Host. H:CTP interrupt not requested. L:CTP request interrupt.
6	XRES	XRES. (T/P)



Note1: ID code Circuit

Vendor ID (On FPC, ID resistor as specified in vendor table shall be connected to this pin, and other side of the resistor shall be connected to GND)



R1=44.2KΩ

Note2: Define the input interface mode

SEL2	SEL1	SEL0	Format	Operating frequency
0	0	0	Parallel-RGB data format (only support stripe type color filter)	6.5MHz
0	0	1	Serial-RGB data format	19.5MHz
0	1	0	CCIR 656 data format (640RGB)	24.54MHz
0	1	1	CCIR 656 data format (720RGB)	27MHz
1	0	0	YUV mode A data format (Cr-Y-Cb-Y)	24.54MHz
1	0	1	YUV mode A data format (Cr-Y-Cb-Y)	27MHz
1	1	0	YUV mode B data format (Cb-Y-Cr-Y)	27MHz
1 /	1	1	YUV mode B data format (Cb-Y-Cr-Y)	24.54MHz

Input format	DOTCLK Freq (MHz)	Display data	Active area (DOTCLK)
YUV mode	24.54	640	1280
TOVIIIode	27	720	1440



2.2.1 Refer Initial code:

//Initial-----

\void Initial_Main(void)

{

MOV DPH,#00H ;Register 0001

MOV DPL,#01H

CALL COM_SER

MOV DPH,#63H

MOV DPL,#00H

CALL DATA_SER

MOV DPH,#00H ;Register 0002

MOV DPL,#02H

CALL COM_SER

MOV DPH,#02H

MOV DPL,#00H

CALL DATA_SER

MOV DPH,#00H ;Register 0003

MOV DPL,#03H

CALL COM_SER

MOV DPH,#011<mark>00100B ;DB3 ~ DB0</mark>

MOV DPL,#01100100B

CALL DATA_SER



MOV **DPH,#00H** ;Register 0004

MOV DPL,#04H

CALL COM_SER

MOV **DPH,#04H**

MOV DPL,#C7H ;Parallel 24 bits

CALL DATA SER

MOV ;Register 0005 DPH,#00H

MOV DPL,#05H

CALL COM_SER

MOV DPH,#FCH

MOV DPL,#80H

CALL DATA_SER

;Register 000A MOV DPH,#00H

MOV DPL,#0AH

CALL COM_SER

MOV DPH,#40H

MOV **DPL,#08H**

CALL DATA_SER

MOV **DPH,#00H** ;Register 000D

DPL,#0DH MOV

CALL COM_SER

MOV DPH,#0000010B



MOV DPL,#00110001B ;DB5 ~ DB0 VLCD63

DATA_SER **CALL**

MOV DPH,#00H ;Register 000E

MOV DPL,#0EH

COM_SER CALL

DPH,#00101110B ;DB4 ~ DB0 VCOM MOV

MOV DPL,#1000000B ;DB7 ~ DB6

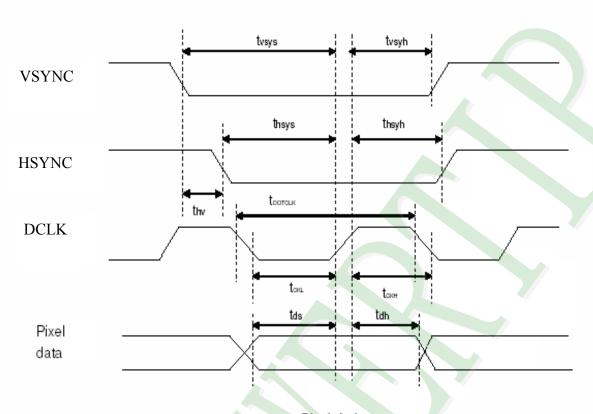
CALL DATA_SER

CALL DELAY2

}



2.3 Timing Characteristics



Pixel timing

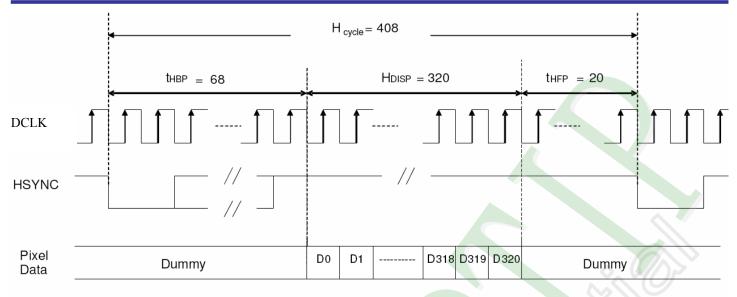
Characteristics	Symbol	Min		Тур		Max		Unit
Characteristics	Syllibol	24 bit	8 bit	24 bit	8 bit	24 bit	8 bit	Ollit
DOTCLK Frequency	fDOTCLK 1			6.5	19.5	10	30	MHz
DOTCLK Period	tDOTCLK	100	33.3	154	51.3	-		ns
Vertical Sync Setup Time	tvsys	20	10			•		ns
Vertical Sync Hold Time	tvsyh	20	10	-		-		ns
Horizontal Sync Setup Time	thsys	20	10	-		-		ทร
Horizontal Sync Hold Time	thsyh	20	10	-		•		ns
Phase difference of Sync Signal Falling Edge	thv	1		-		24	40	tDOTCLK
DOTCLK Low Period	tCKL	50	15	-		-		ns
DOTCLK High Period	tCKH	50	15	-				ns
Data Setup Time	tds	12	10	-				ns
Data hold Time	tdh	12	10	-		•		ns
Reset pulse width	tRES	1	•					us

Note: External clock source must be provided to DOTCLK pin of HX8238-A. The driver will not operate if absent of the clocking signal.

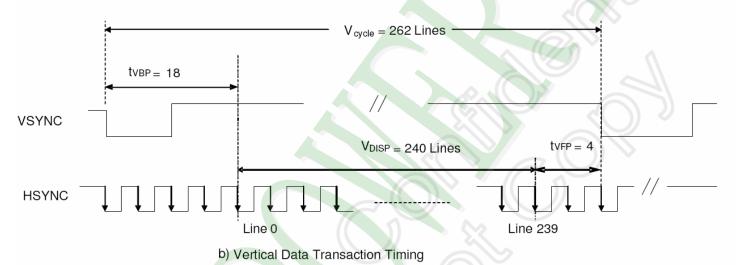
Pixel timing

Note: The interface of this module can drive by digital 24-bit data.





a) Horizontal Data Transaction Timing



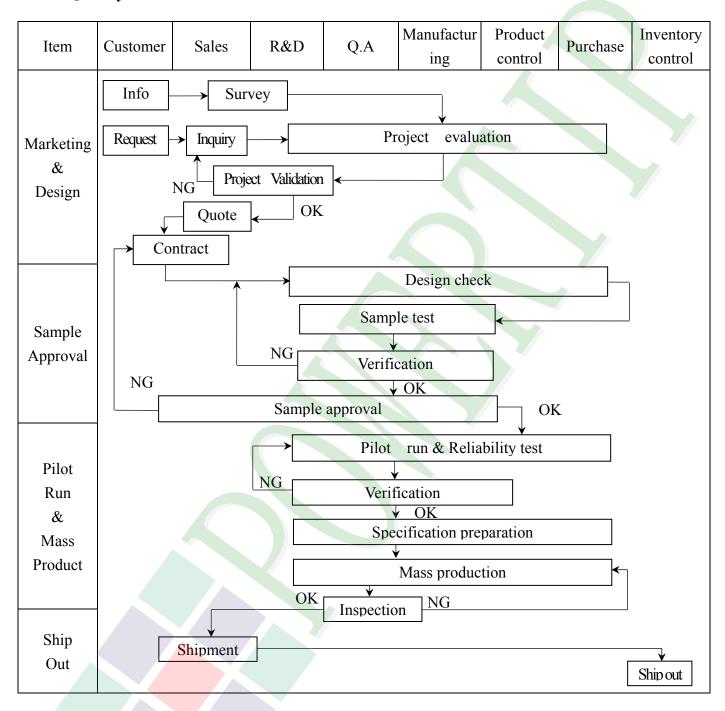
Data transaction timing in parallel RGB(24 bit)interface (SYNC mode)



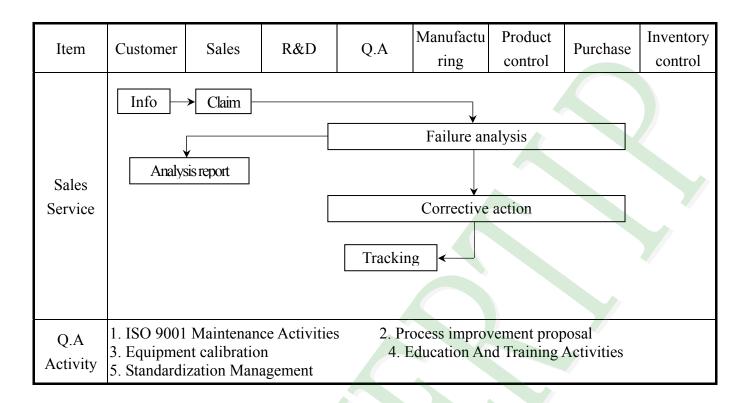


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



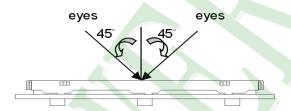




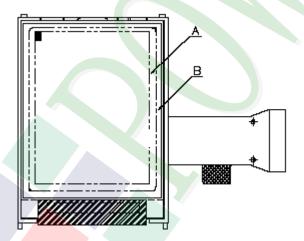


3.2. Inspection Specification

- ◆ Scope: The document shall be applied to TFT-LCD Module for 3.5" ~15" (Ver.B01).
- ◆ Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- **♦** Equipment : Gauge > MIL-STD > Powertip Tester > Sample
- ◆ Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5
- **♦** OUT Going Defect Level: Sampling.
- ◆ Standard of the product appearance test:
 - a. Manner of appearance test:
 - (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
 - (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



igspace Specification For TFT-LCD Module 3. 5" ~15":

NO	Item	Criterion				
		1. 1The part number is inconsistent with work order of production.				
01	Product condition	1. 2 Mixed product types.	Major			
		1. 3 Assembled in inverse direction.				
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major			
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major			
		4. 1 Missing line character and icon.	Major			
		4. 2 No function or no display.	Major			
	Electrical Testing	4. 3 Display malfunction.				
04		4. 4 LCD viewing angle defect.				
		4. 5 Current consumption exceeds product specifications.				
		4. 6 Mura can not be seen through 5% ND filter. (Mura: Under the normal examination angle of view, the picture has the non-uniform phenomenon.)	Minor			
		Item Acceptance (Q'ty)				
		Bright Dot ≤ 4				
	Dot defect	Dot Dark Dot ≤ 5				
		Defect Joint Dot ≤ 3				
05	(Bright dot \ Dark dot)	Total ≤ 7	Minor			
	On -display	5. 1 Inspection pattern: full white, full black, Red, Green and blue screens. 5. 2 It is defined as dot defect if defect area > 1/2 dot. 5. 3 The distance between two dot defect > 5 mm				
		5. 3 The distance between two dot defect ≥5 mm.5. 4 Bright dot that can not be seen through 5% ND filter.				



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO	Item	Criterion					
NO	Black or white dot \ scratch \ contamination Round type	0.25 <	n-display or didiameter : Φ) $\Phi \le 0.25$ $\Phi \le 0.50$ $\Phi > 0.50$ otal	Acceptan A area Ignore 5 0 5	ce (Q'ty) B area Ignore		Level
06	$\Phi = (x+y)/2$ Line type $\downarrow W$ $3.5" \text{ to less } 9"$	module size L 3.5" to less 9" L	Marcong th	Vidth (W) $W \le 0.03$ $< W \le 0.05$ $< W \le 0.10$ $W > 0.10$ $W \le 0.05$ $< W \le 0.10$ $W \ge 0.10$ $W > 0.10$	Acceptance A area Ignore 4 2 As round type 5 Ignore 5 As round type 5	e (Q'ty) B area Ignore	Minor
07	Polarizer Bubble	$0.25 < \Phi$ $0.50 < \Phi$	$0 \le 0.25$ $0 \le 0.50$ $0 \le 0.80$	Acceptan A area Ignore 4 1 0	Ice (Q'ty) B are		Minor



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion		Level
		Z: The thickness of crack	Y: The width of crack. W: terminal length a: LCD side length	
		8. 1 General glass chip:8. 1. 1 Chip on panel surface and crack between panels:		
		Z Z	Z	
08	The crack of glass	SP Y [OK]	SP [NG]	Minor
		Seal width	Y	
		Z*		
		X Y Crack can't enter	Z	
		≤ a viewing area	≦1/2 t	
ı		≤ a Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$	



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion					
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1. 2 Corner crack:					
		8. 1. 2 Corner Crack .					
		X Y Z					
		$\leq 1/5$ a Crack can't enter viewing area $Z \leq 1/2$ t					
08	The exact of alone		Minor				
00	The crack of glass	8.2 Flotiusion over terminar.					
		8. 2. 1 Chip on electrode pad:					
		W					
		X Y Z					
		Front $\leq a$ $\leq 1/2 W$ $\leq t$					
		Back $\leq a$ $\leq W$ $\leq 1/2 t$					



◆Specification For TFT-LCD Module 3. 5″ ~15″:



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO	Item	Criterion	Level
09	Backlight elements	9. 1 Backlight can't work normally.	Major
		9, 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
	diagram. 10. 2 No short circuits in components on PCB or FPC. 10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. General appearance	10. 1 Pin type \quantity \	Major
		10. 2 No short circuits in components on PCB or FPC.	Major
		Major	
10		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

NO.	TEST ITEM		TEST CONDITION				
1	High Temperature	-) ±2°C 240hrs				
	Storage Test			orage at normal condition	on 4hrs.		
2	Low Temperature	-	±2°C 240hrs				
	Storage Test	1	<u> </u>	orage at normal condition	on 4hrs.		
	High Temperature /	Keep in +60 °C / 90% R.H duration for 240hrs					
3	High Humidity Storage Test		Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)				
	Storage Test	(Excluding		→ +80°C → +25°C	<u> </u>		
4	Temperature Cycling		(30mins) (5mins)		Y		
	Storage Test		20 C	•			
		Surroundin	g temperature, then sto	orage at normal condition	on 4hrs.		
		Air Dischar		Contact Discharge:			
			with 5 times	Apply 250 V with 5 tir			
		Discharge fo	or each polarity +/-	discharge for each pola			
		1. Temperature ambiance : 15° C $\sim 35^{\circ}$ C					
5	ECD Took	2. Humidity relative: 30%~60%					
J	ESD Test	3. Energy Storage Capacitance(Cs+Cd): 150pF± 10%					
		4. Discharge Resistance(Rd): 330 Ω±10%					
		5. Discharge, mode of operation:					
		Single Discl	harge (time between s	uccessive discharges at	least 1 sec)		
		(Tolerance i	f the output voltage inc	lication: ±5%)			
			1. Sine	wave $10 \sim 55$ Hz fr	requency (1		
	Vibration Test		min/sw	veep)			
6	(Packaged)	2. The amplitude of vibration :1.5 mm					
		3. Each di	rection (X \ Y \ Z) dur	-			
			Packing Weight (Kg)	Drop Height (cm)]		
		7	$0 \sim 45.4$	122	-		
			45.4 ~ 90.8	76	-		
7	Drop Test (Packaged)		90.8 ~ 454	61	-		
			0ver 454	46	_		
		Drop Direct	ion :※1 corner / 3 edge	es / 6 sides each 1time			



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM
- 5.2.10 Caution!(LCM products with Capacitive Touch Panel)
 Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).
 Therefore, the touch needs to be thoroughly tested inside the target application.

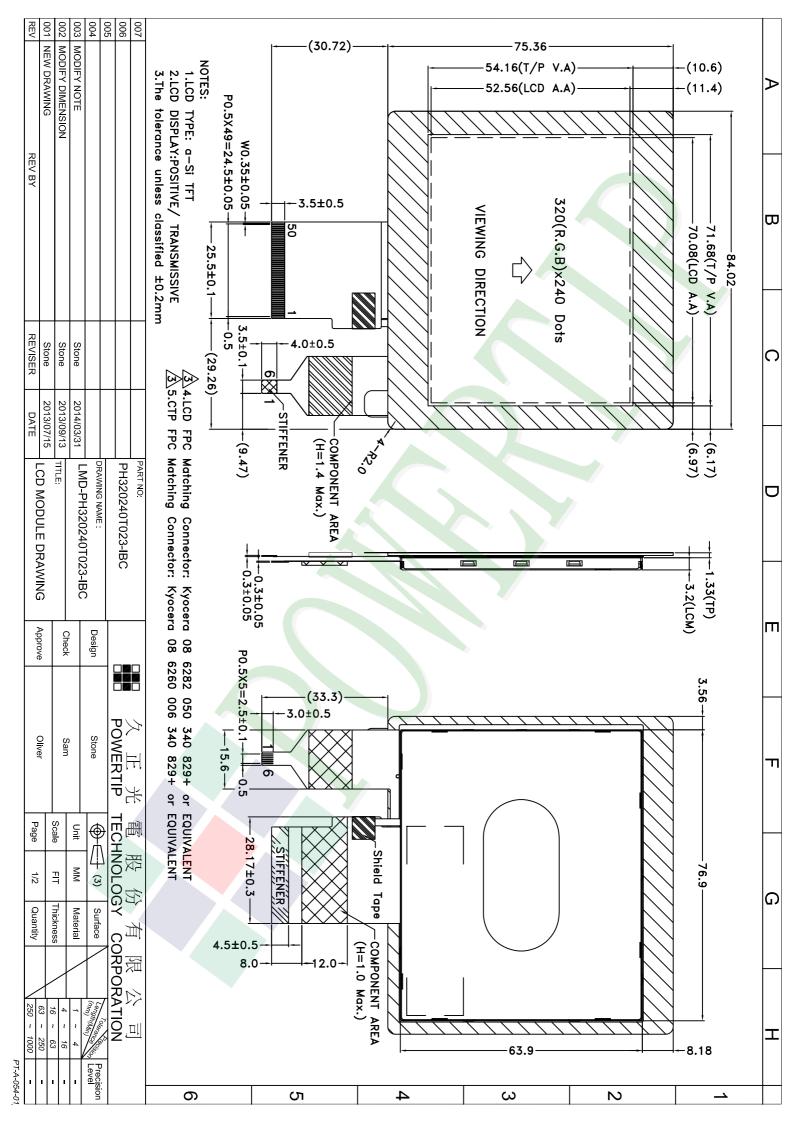
5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period

 The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.003 LCM包裝規格書 Ryan Eddy Terry Documents NO. JPKG-PH320240T023-IBC LCM Packaging Specifications 1.包裝材料規格表 (Packaging Material): (per carton) 1Pcs Weight Total Weight No. Item Model Dimensions (mm) Quantity 1 成品 (LCM) PH320240T023-IBC 84.02 X 75.36 0.045 120 5.4 2 抗靜電氣泡袋(1)Bubble Bag BAG000000005 0.002 0.24 150 X 120 120 3 A2隔板(2)A2 Partition BX29300070BMBA 293 X 70 X 2.5 0.011 66 0.726 B2隔板(3)B2 Partition 4 BX24500070BLBA 245 X 70 X 2.5 0.01 18 0.18 5 海綿墊(4)Foam Rubber Cushion 12 OTFOAM00006ABA 290 X 240 X 10 0.02 0.24 C3内盒(5)Product Box 6 6 BX31025510ABBA 310 X 255 X 100 0.263 1.578 7 外紙箱(6)Carton BX52732536CDBA 527 X 325 X 360 0.83 1 0.83 8 9 2. 一整箱總重量 (Total LCD Weight in carton): Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)Quantity Of Spacer: A2隔板 X 11, B2隔板 X 3 (2)Total LCM quantity in carton: quantity per box x no of boxes 120 6 (4) 海綿墊 Foam Rubber Cushion (1)抗靜電氣泡袋+LCM Bubble Bag+LCM (2)(3)隔板 Partition 仆 (4) 海綿墊 Foam Rubber Cushion (6)外紙箱 Carton (5)C3内盒 Product Box 特 記 事 項 (REMARK) 1. LCM排放示意圖(前後<mark>間隔不放</mark>置): 1. LCM placed as figure showing: (First and last slot should be empty)

Ø 模組(LCM) X 1pcs.